

In re Applicant:

2814

Ilya Karpov et al.

Examiner:

Art Unit:

Long Pham

Serial No.:

Filed:

10/822,361

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Docket:

ITL.0835D1US

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§

Fabricating Deeper and Shallower For:

Assignee:

**Intel Corporation** 

Trenches in Semiconductor Structures

§

Conf. No.

3077

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## **RESPONSE TO PAPER NO. 04282006**

Sir:

In response to the Office action mailed on May 2, 2006, please consider the following amendments and remarks.

Date of Deposit: <u>August 2, 2006</u>
I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as **first class** mail with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.